

NPN Silicon Transistor FJB5555

Features

- Fast Speed Switching
- Wide Safe Operating Area
- High Voltage Capability
- This is a Pb-Free and Halide Free Device

Applications

- Electronic Ballast
- Switched Mode Power Supplies

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

Symbol	Parameter	Value	Unit	
BV _{CBO}	Collector-Base Voltage	1050	V	
BV _{CEO}	Collector-Emitter Voltage	400	V	
BV _{EBO}	Emitter-Base Voltage	14	V	
I _C	Collector Current (DC)	5	Α	
I _{CP}	Collector Current (Pulse)	10	Α	
Ι _Β	Base Current (DC)	2	Α	
I _{BP}	Base Current (Pulse)	4	Α	
T_J	Junction Temperature	150	°C	
T _{STG}	Storage Junction Temperature Range	-55 to +150	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

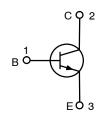
THERMAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

Symbol	Parameter		Value	Unit
P_{D}	Total Device Dissipation	issipation T _A = 25 °C		W
		T _C = 25 °C	100	W
R _{θja}	Thermal Resistance, Junction to Ambient (Note 1)		77.75	°C/W
R _{θjc}	Thermal Resistance Junction to Case (Note 2)		1.25	°C/W

- 1. Device mounted on FR-4 PCB, board size = 101.5 mm \times 114.5 mm.
- 2. $R_{\theta jc}$ test fixture under infinite cooling condition.



D2PAK-3 (TO-263, 3-LEAD) CASE 418AJ



- 1. Base
- 2. Collector
- 3. Emitter

MARKING DIAGRAM

AWWYZ J5555

A = Assembly Location WW = Work Week

Y = Year

Z = Lot Traceability J5555 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping [†]		
FJB5555TM	D2PAK-3	800 /		
	(TO-263, 3-LEAD)	Tape & Reel		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

FJB5555

ELECTRICAL CHARACTERISTICS ($T_C = 25 \, ^{\circ}C$ unless otherwise noted) (Note 3)

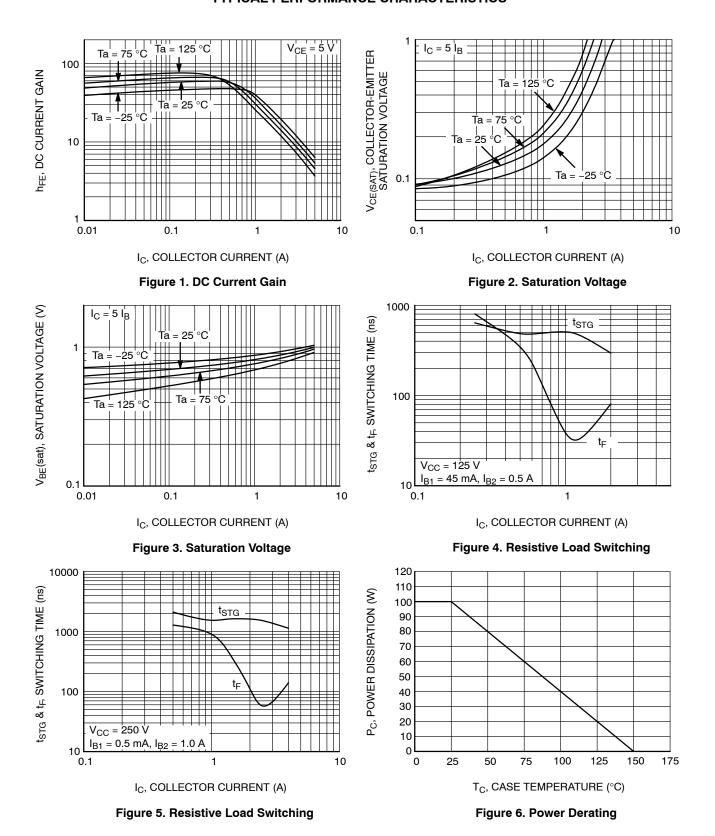
Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
BV _{CBO}	Collector-Base Breakdown Voltage	I _C = 500 μA, I _E = 0	1050	-	-	V
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = 5 mA, I _B = 0	400	-	-	V
BV _{EBO}	Emitter-Base Breakdown Voltage	I _E = 500 μA, I _C = 0	14	-	-	V
h _{FE}	DC Current Gain	V _{CE} = 5 V, I _C = 10 mA	10	-	-	
		V _{CE} = 3 V, I _C = 0.8 A	20	-	40	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 1 A, I _B = 0.2 A	-	0.17	0.50	V
		I _C = 3.5 A, I _B = 1.0 A	-	-	1.5	V
V _{BE(sat)}	Base-Emitter Saturation Voltage	I _C = 3.5 A, I _B = 1.0 A	-	-	1.2	V
C _{ob}	Output Capacitance	V _{CB} = 10 V, f = 1 MHz	-	45	-	pF
t _{ON}	Turn-On Time	V _{CC} = 125 V, I _C = 0.5 A,	-	-	1.0	μs
tsтG	Storage Time	I_{B1} = 45 mA, I_{B2} = -0.5 A, I_{L} = 250 Ω	-	-	1.2	μs
t _F	Fall Time]	-	0.3	-	μs
t _{ON}	Turn-On Time	$V_{CC} = 250 \text{ V}, I_{C} = 2.5 \text{ A}, \\ I_{B1} = 0.5 \text{ A}, I_{B2} = -1.0 \text{ A}, \\ R_{L} = 100 \Omega$	-	-	2.0	μs
tsтG	Storage Time		-	-	2.5	μs
t _F	Fall Time]	-	-	0.3	μs
EAS	Avalanche Energy	L = 2 mH	6	-	-	mJ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$

FJB5555

TYPICAL PERFORMANCE CHARACTERISTICS



FJB5555

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

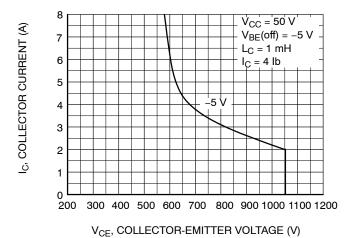


Figure 7. Reverse Bias Safe Operating





0.653

2x 0.063

D²PAK-3 (TO-263, 3-LEAD) CASE 418AJ ISSUE F

DATE 11 MAR 2021

NOTES

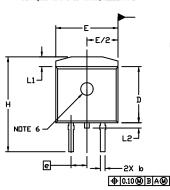
0.366

0.169

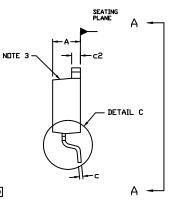
0.100 PITCH

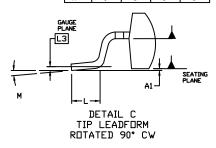
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- CONTROLLING DIMENSION: INCHES
- CHAMFER OPTIONAL
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.005 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE DUTERMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
- 5. THERMAL PAD CONTOUR IS OPTIONAL WITHIN DIMENSIONS E, L1, D1, AND E1.
- 6. OPTIONAL MOLD FEATURE.
- 7. ①,② ... OPTIONAL CONSTRUCTION FEATURE CALL DUTS.

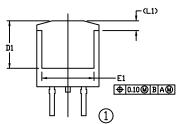
	INCHES		MILLIMETERS	
DIM	MIN.	MAX.	MIN.	MAX.
A	0.160	0.190	4.06	4.83
A1	0.000	0.010	0.00	0.25
b	0.020	0.039	0.51	0.99
U	0.012	0.029	0.30	0.74
5	0.045	0.065	1.14	1.65
D	0.330	0.380	8.38	9.65
D1	0.260		6.60	
E	0.380	0.420	9.65	10.67
E1	0.245		6.22	
e	0.100 BSC		2.54 BSC	
Ξ	0.575	0.625	14.60	15.88
L	0.070	0.110	1.78	2.79
L1		0.066		1.68
L2		0.070		1.78
L3	0.010 BSC		0.25 BSC	
М	0*	8.	0*	8•



RECOMMENDED MOUNTING FOOTPRINT





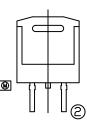


XXXXXXXX

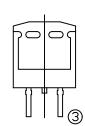
IC

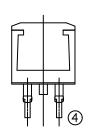
AWLYWWG

VIEW A-A



GENERIC MARKING DIAGRAMS*





VIEW A-A OPTIONAL CONSTRUCTIONS

XXXXXX

XXYMW

SSG

AYWW

XXXXXXXXX

Rectifier

AKA

XXXXXX = Specific Device Code = Assembly Location Α

WL = Wafer Lot = Year ww

= Work Week W = Week Code (SSG) Μ = Month Code (SSG) G = Pb-Free Package = Polarity Indicator **AKA**

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products

may not follow the Generic Marking.

DOCUMENT NUMBER:

98AON56370E

Standard

XXXXXXXX

AYWW

Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.

DESCRIPTION: D²PAK-3 (TO-263, 3-LEAD) PAGE 1 OF 1

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. **onsemi** makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales